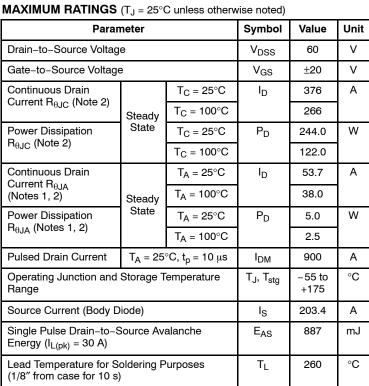
## **<u>MOSFET</u>** – Power, Single N-Channel 60 V. 0.91 mΩ, 376 A

# NVMTS001N06C

#### Features

- Small Footprint (8x8 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- Wettable Flank Plated for Enhanced Optical Inspection
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be

## THERMAL RESISTANCE MAXIMUM RATINGS

assumed, damage may occur and reliability may be affected.

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	0.614	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	30.10	

1. Surface-mounted on FR4 board using a 1 in<sup>2</sup> pad size, 1 oz. Cu pad.

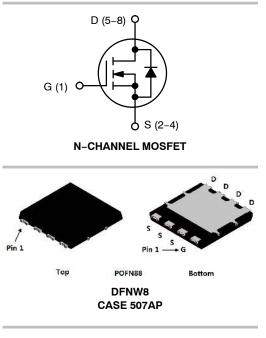
The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.



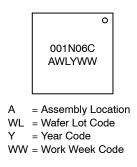
## **ON Semiconductor®**

#### www.onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
60 V	0.91 mΩ @ 10 V	376 A



#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

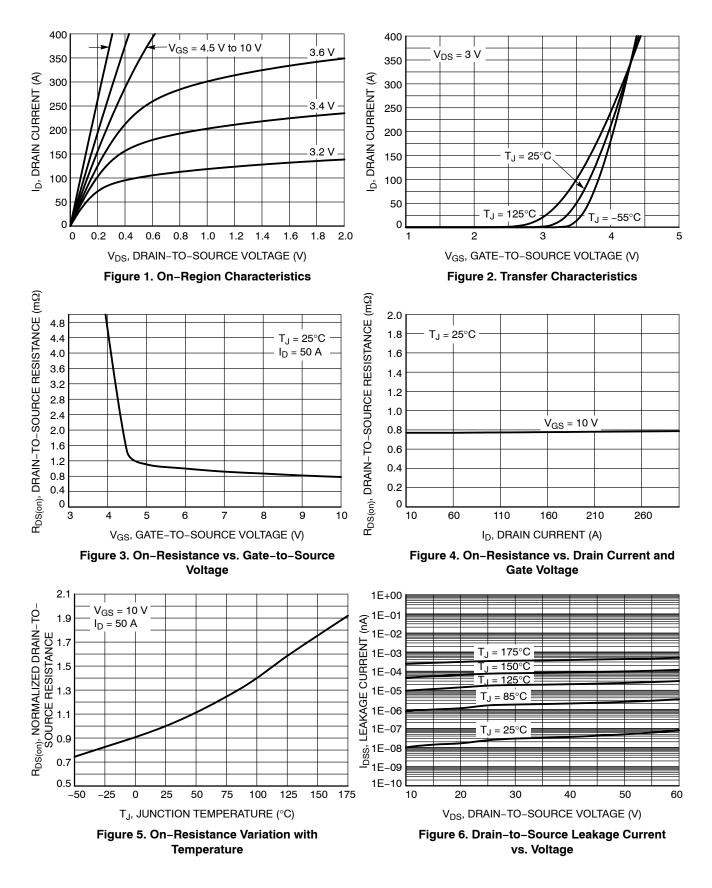
Semiconductor Components Industries, LLC, 2019 April, 2020 – Rev. 1

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise specified)

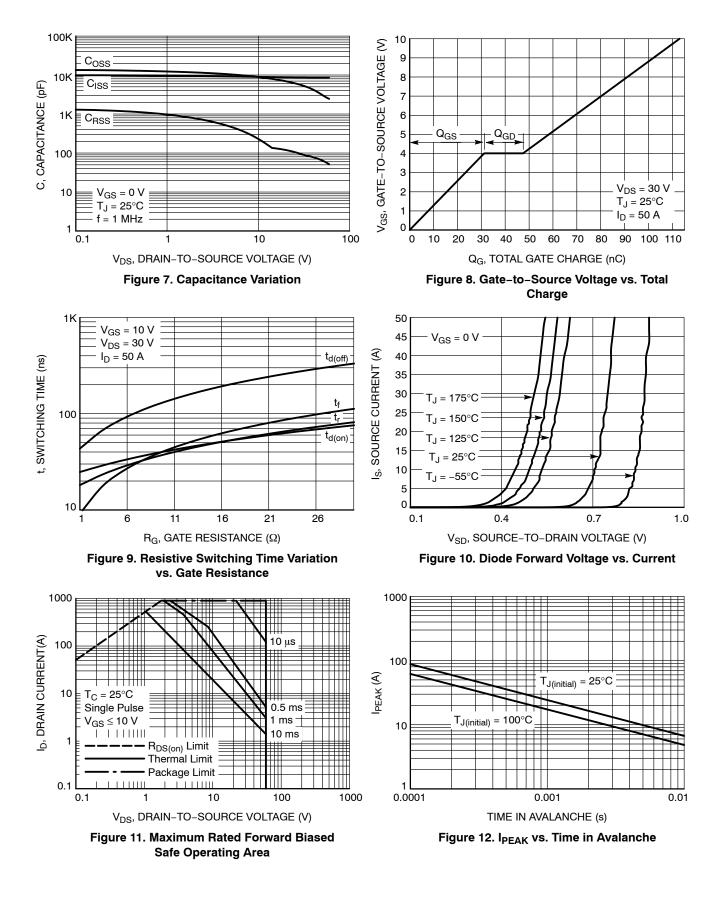
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>	$I_D$ = 250 µA, ref to 25°C			22		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$ , $T_J = 25^{\circ}C$				10	
		$V_{\rm DS} = 60 \text{ V}$	T <sub>J</sub> = 125°C			250	μΑ
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA
ON CHARACTERISTICS (Note 3)						-	-
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D =$	= 250 μA	2.0		4.0	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>	I <sub>D</sub> = 250 μA, re	f to 25°C		7.75		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 50 A		0.77	0.91	mΩ
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> =5 V, I <sub>D</sub> = 50 A			160		S
Gate Resistance	R <sub>G</sub>	$T_A = 25^{\circ}C$			1.5		Ω
CHARGES, CAPACITANCES & GATE RESIS	TANCE				•		
Input Capacitance	C <sub>ISS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 30 V			8705		pF
Output Capacitance	C <sub>OSS</sub>				6690		
Reverse Transfer Capacitance	C <sub>RSS</sub>				107		
Total Gate Charge	Q <sub>G(TOT)</sub>	$V_{GS} = 10 \text{ V}, V_{DS} = 30 \text{ V}; I_D = 50 \text{ A}$ $V_{GS} = 10 \text{ V}, V_{DS} = 30 \text{ V}; I_D = 50 \text{ A}$			113		
Threshold Gate Charge	Q <sub>G(TH)</sub>				19.5		nC
Gate-to-Source Charge	Q <sub>GS</sub>				31.2		
Gate-to-Drain Charge	Q <sub>GD</sub>				16.3		
Voltage Plateau	V <sub>GP</sub>				4.01		V
SWITCHING CHARACTERISTICS, $V_{GS} = 10$	V (Note 4)					-	-
Turn-On Delay Time	t <sub>d(ON)</sub>				27.4		
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = 10 V, V <sub>D</sub>	s = 30 V,		21.4		1
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$I_D = 50 \text{ A}, \text{ R}_G = 2.5 \Omega$			58.3		- ns
Fall Time	t <sub>f</sub>				14.5		
DRAIN-SOURCE DIODE CHARACTERISTIC	s					-	-
Forward Diode Voltage	V <sub>SD</sub> V	$V_{GS} = 0 V,$ $I_{S} = 50 A$	$T_J = 25^{\circ}C$		0.78	1.2	
			T <sub>J</sub> = 125°C		0.63		- V
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dIS/dt = 100 A/µs, I <sub>S</sub> = 50 A			100		
Charge Time	t <sub>a</sub>				66.3		ns
Discharge Time	t <sub>b</sub>				43.7		
Reverse Recovery Charge	Q <sub>RR</sub>				236		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ . 4. Switching characteristics are independent of operating junction temperatures.

## **TYPICAL CHARACTERISTICS**



#### **TYPICAL CHARACTERISTICS**



## **TYPICAL CHARACTERISTICS**

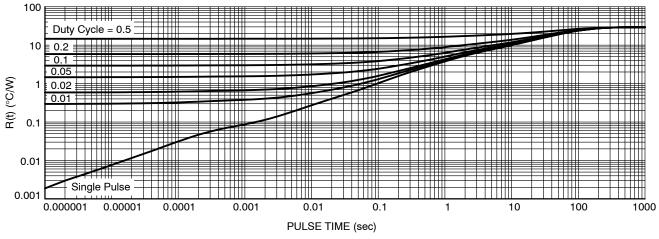


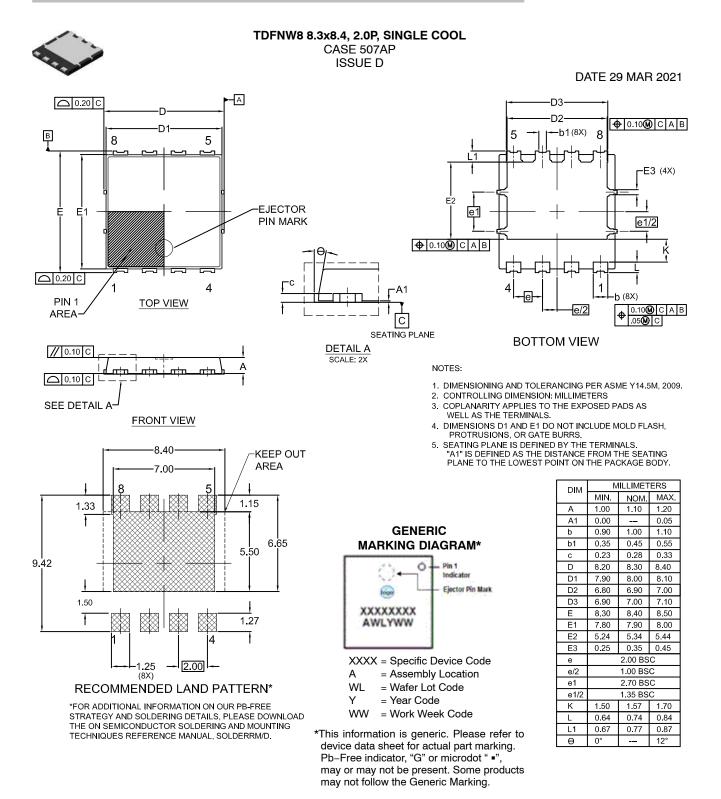
Figure 13. Thermal Characteristics

#### **DEVICE ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
NVMTS001N06CTXG	001N06C	DFNW8 (Pb–Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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DESCRIPTION:	TDFNW8 8.3x8.4, 2.0P, SINGLE COOL		PAGE 1 OF 1		

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